



Understanding electrode plasma formation on wires and thin foils via vacuum ultraviolet spectroscopy of desorbed surface contaminants

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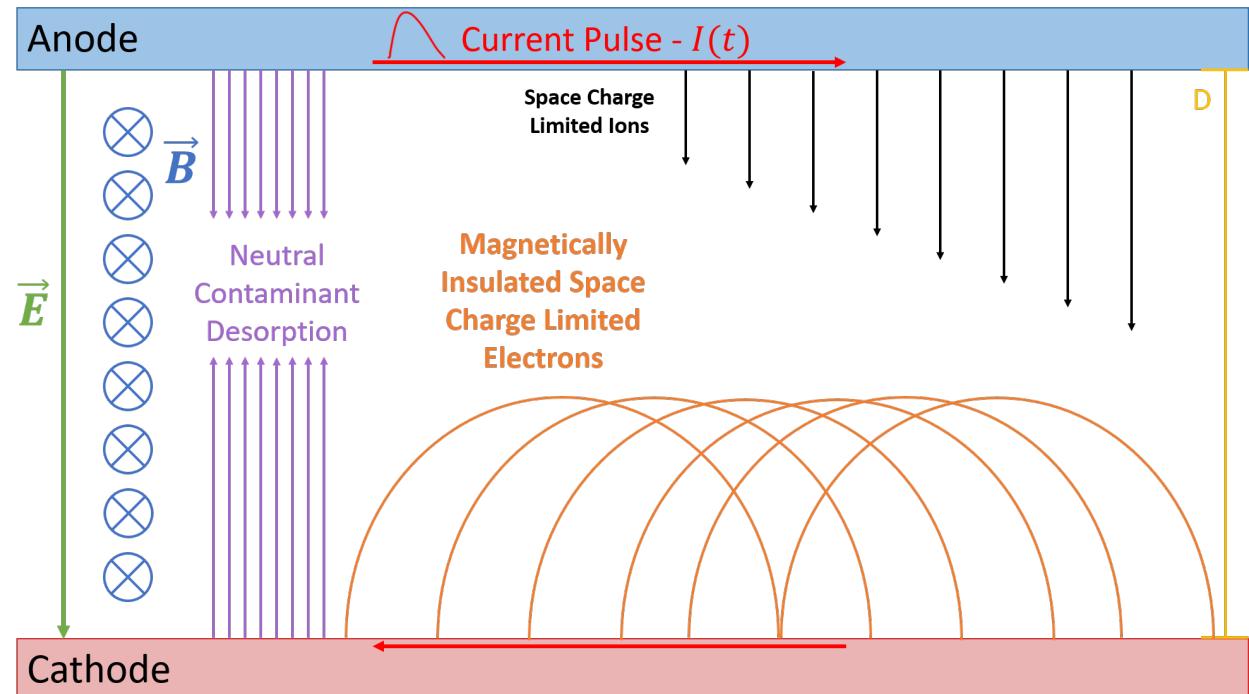
2: Sandia National Laboratories

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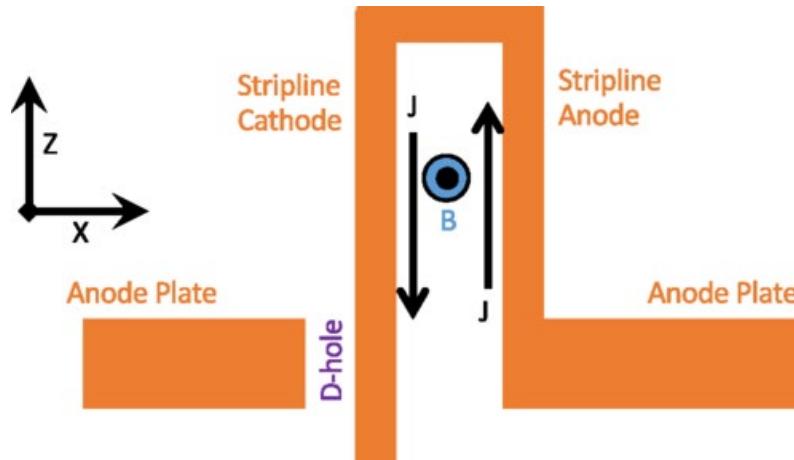
What is Power Flow for Current Delivery?

- The study of how power is delivered from the capacitor banks to the load region
 - Specifically, the magnetically insulated transmission lines in the vacuum section of a pulsed power driver
- Electrodes heat due to ohmic heating, charged particle bombardment, etc.
- This heating liberates contaminants from surface/bulk and ionize
- A strong magnetic field insulates the plasma from crossing the gap
- Plasma drifts along electrodes
- Current loss occurs when a weak or no magnetic field is present to insulate the plasma



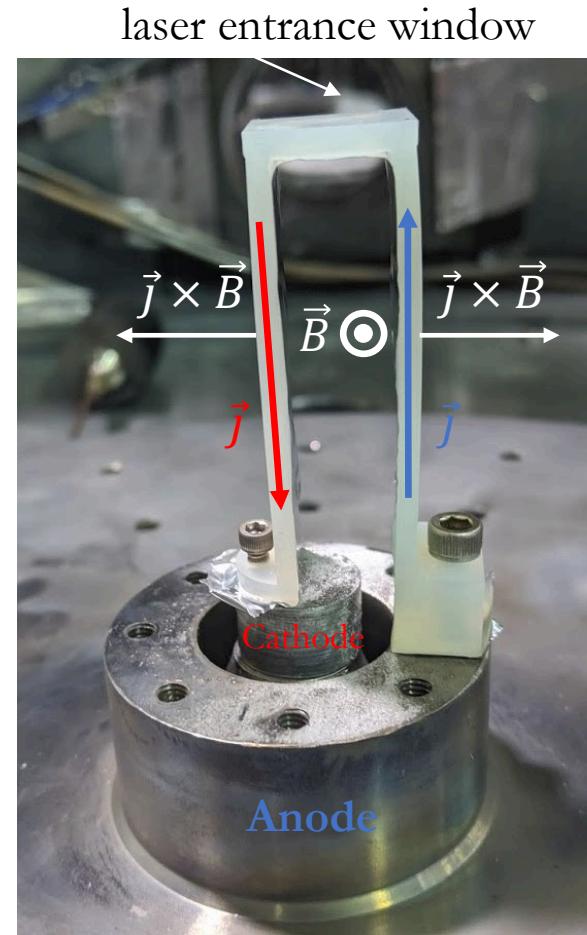
M.R. Gomez *et al.* **PRAB** (2017)
[10.1103/PhysRevAccelBeams.20.010401](https://doi.org/10.1103/PhysRevAccelBeams.20.010401)

New Power Flow Platform at the University of Michigan

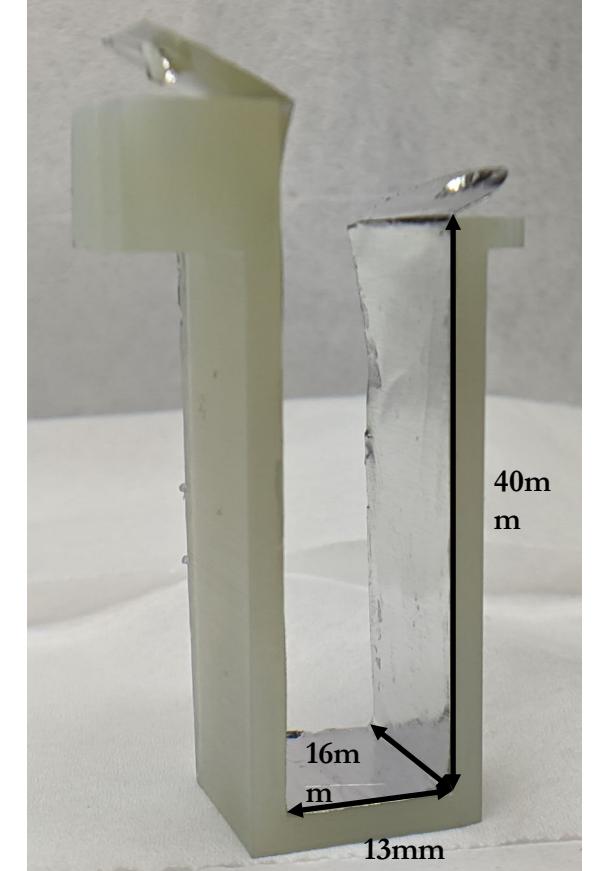


Strip-line flyer plate geometry used on the Z-machine
for dynamic material property experiments

A. Porwitzky *et al.* **PRAB** (2019)



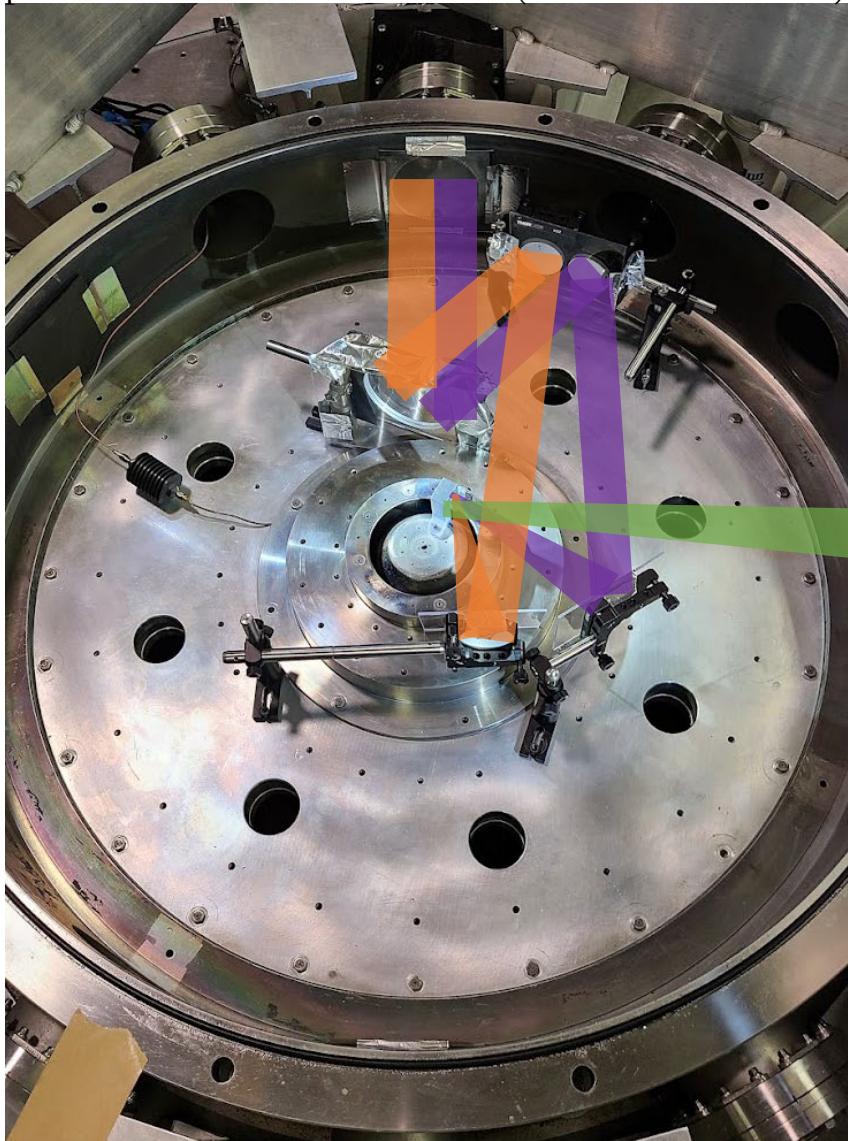
Target in situ inside MAIZE vacuum chamber
50 μm Aluminum Planar Foil
 $R = 3.6 \text{ m}\Omega$
 $L = 20-50 \text{ nH}$



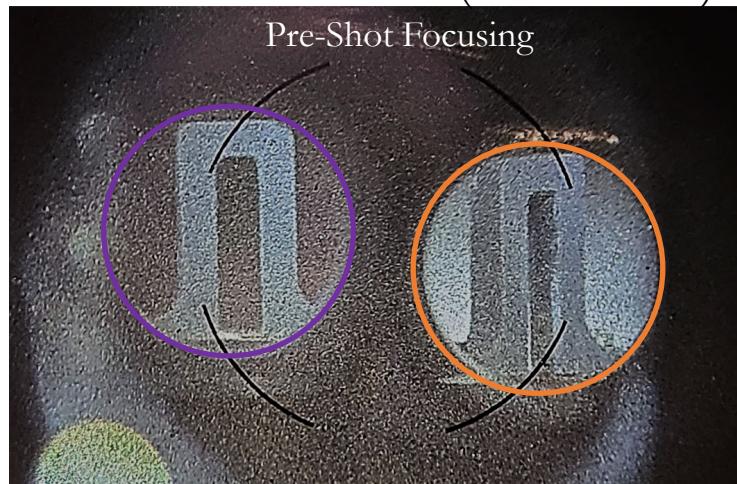
- 3D Printed Support Structure
- Uses Form 2 SLA printer
- Durable Resin
- 31.8 MPa tensile strength

Imagining Lines of Sight - Examples

Optical Paths for Mirrors/XUV (Color Coordinated)

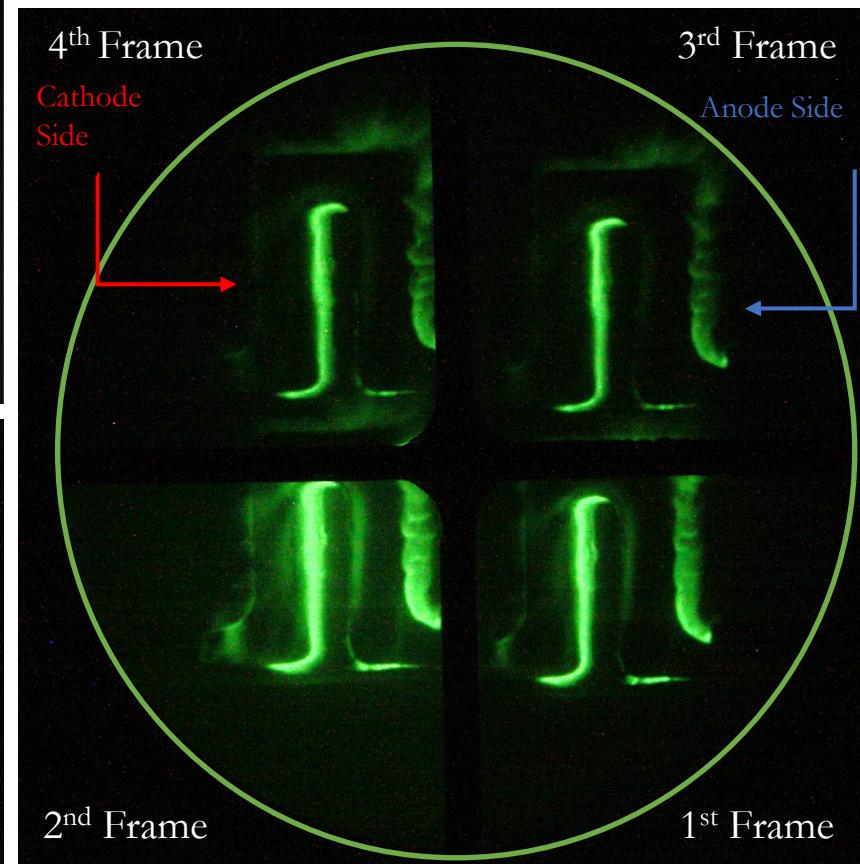


Visible Self Emission (12 – Frames)

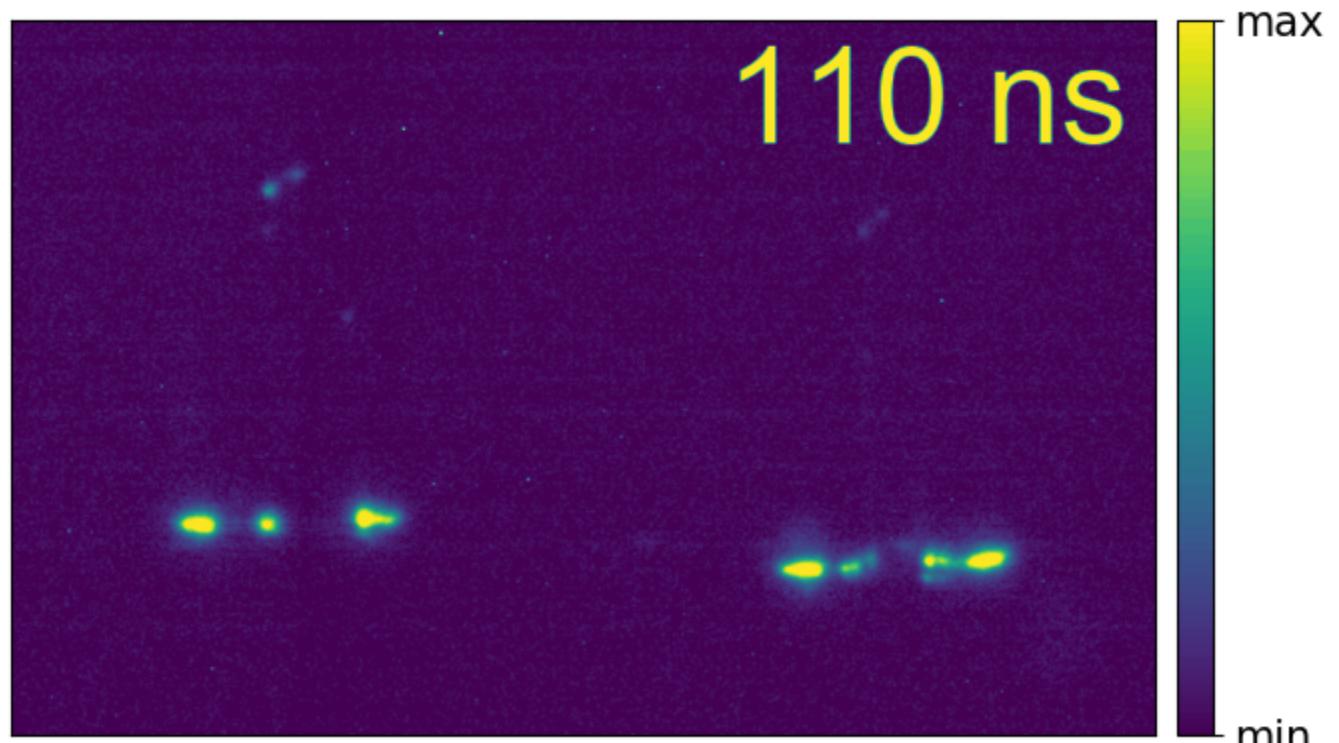
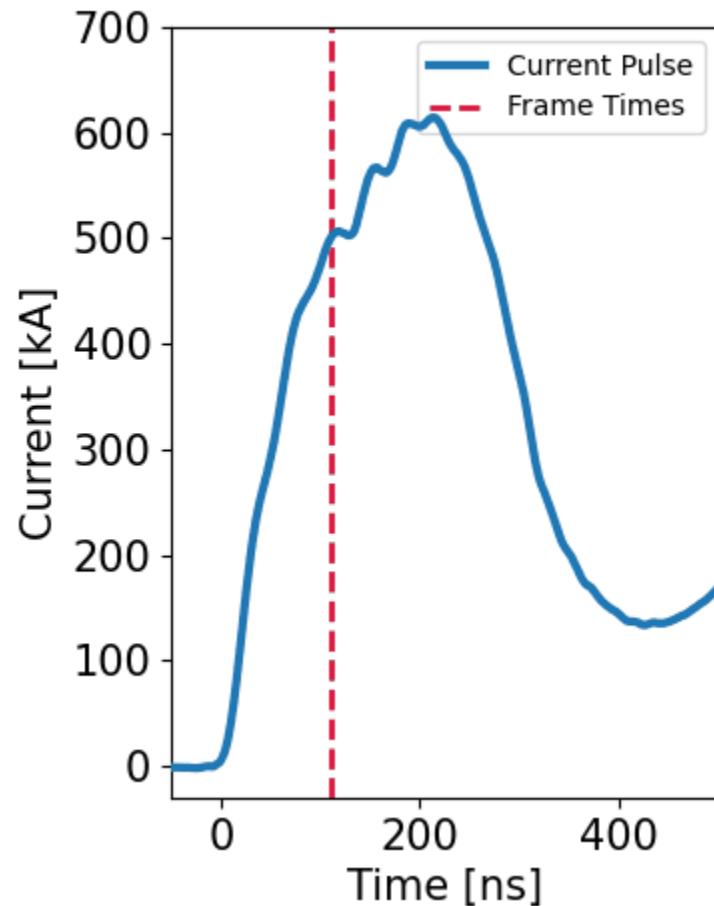


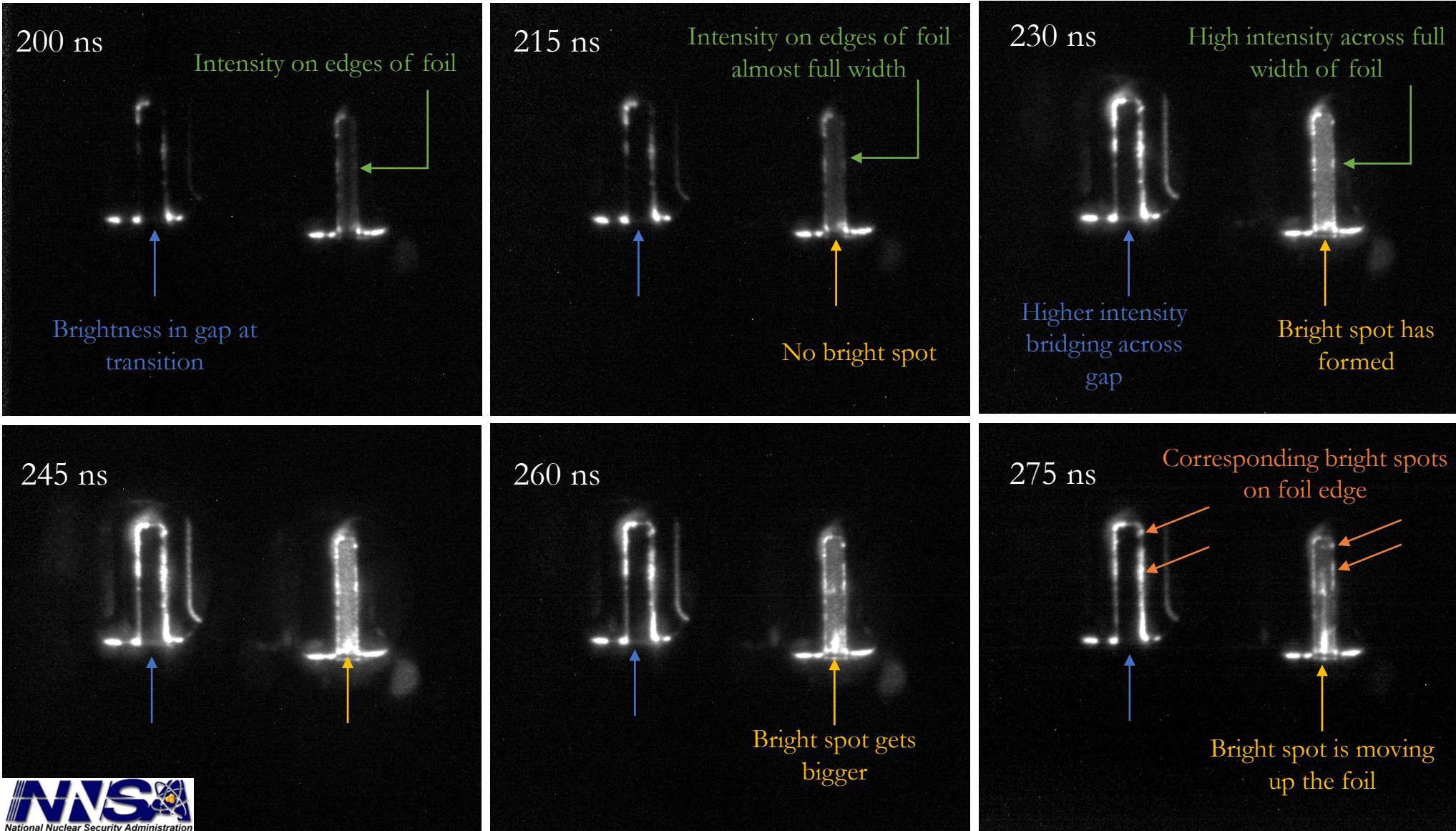
Shot 2314

XUV MCP Pinhole Self Emission (4 – Frames)



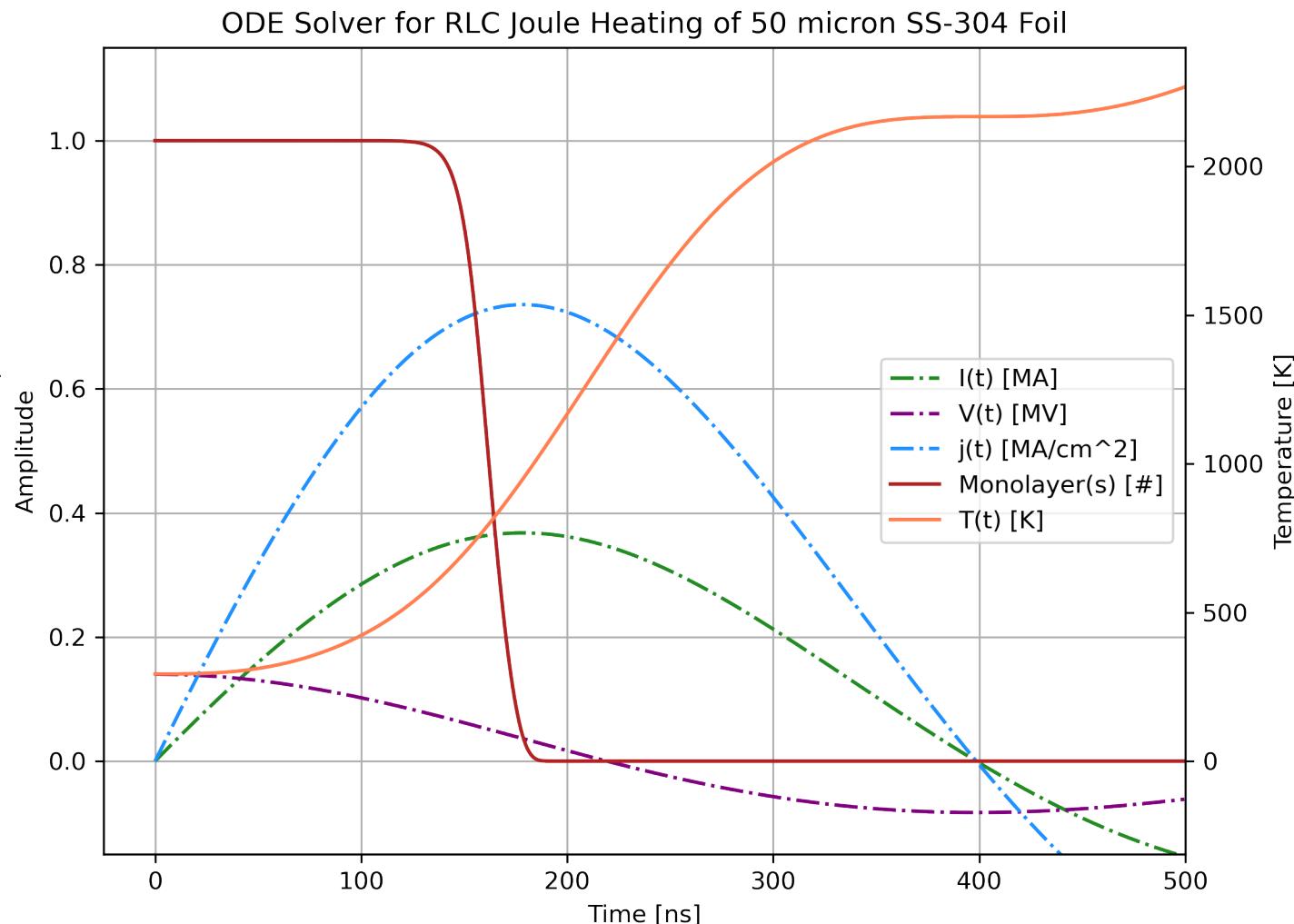
Shot 2317

Visible Self Emission Imaging - Shot 2314 – 25- μ m Al

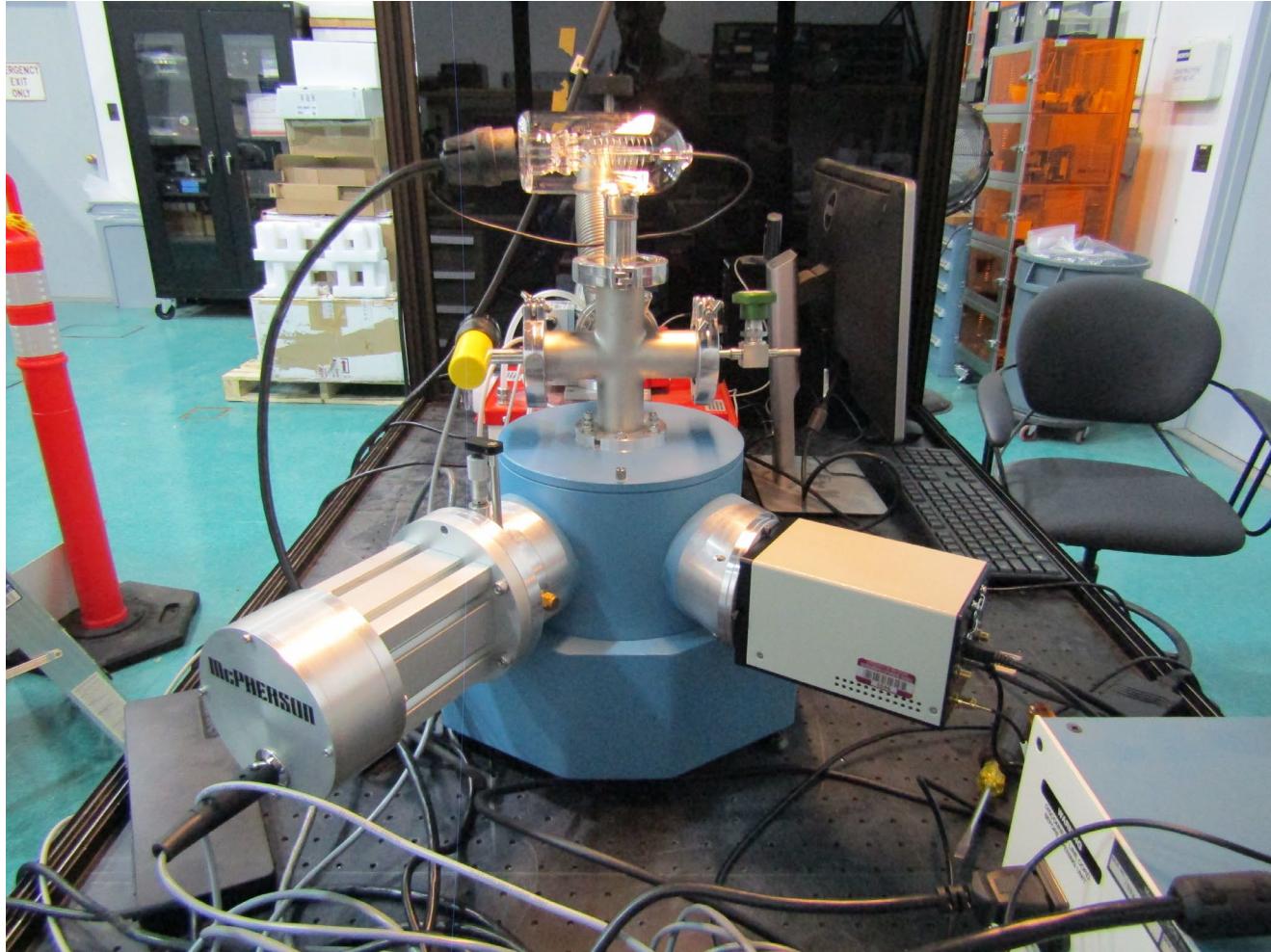
Visible Self Emission Imaging - Shot 2314 – 25- μ m Al

Semi-Analytic Model for Foil Heating & Contaminant Desorption

- Python ODE solver solves RLC voltage driven/user defined current trace to determine solid foil temperature and rate of neutral contaminant desorption
- Knoepfel model defines rate of heat entering through resistive Joule heating
 - $\frac{\partial Q}{\partial t} = \frac{j^2}{\sigma} + k\Delta T$
- Modified Temkin Isotherm, E' , determines rate of desorption of contaminant surface layers
 - $\frac{dn}{dt} = k_0 n_m \theta e^{-E'/k_B T}$
- Solver gives semi-analytic solution in a matter of seconds
- Currently working to add
 - heat transfer from skin depth to foil bulk
 - bulk hydrogen desorption
 - metal vaporization
 - ionization



Spectrometer Calibration Setup



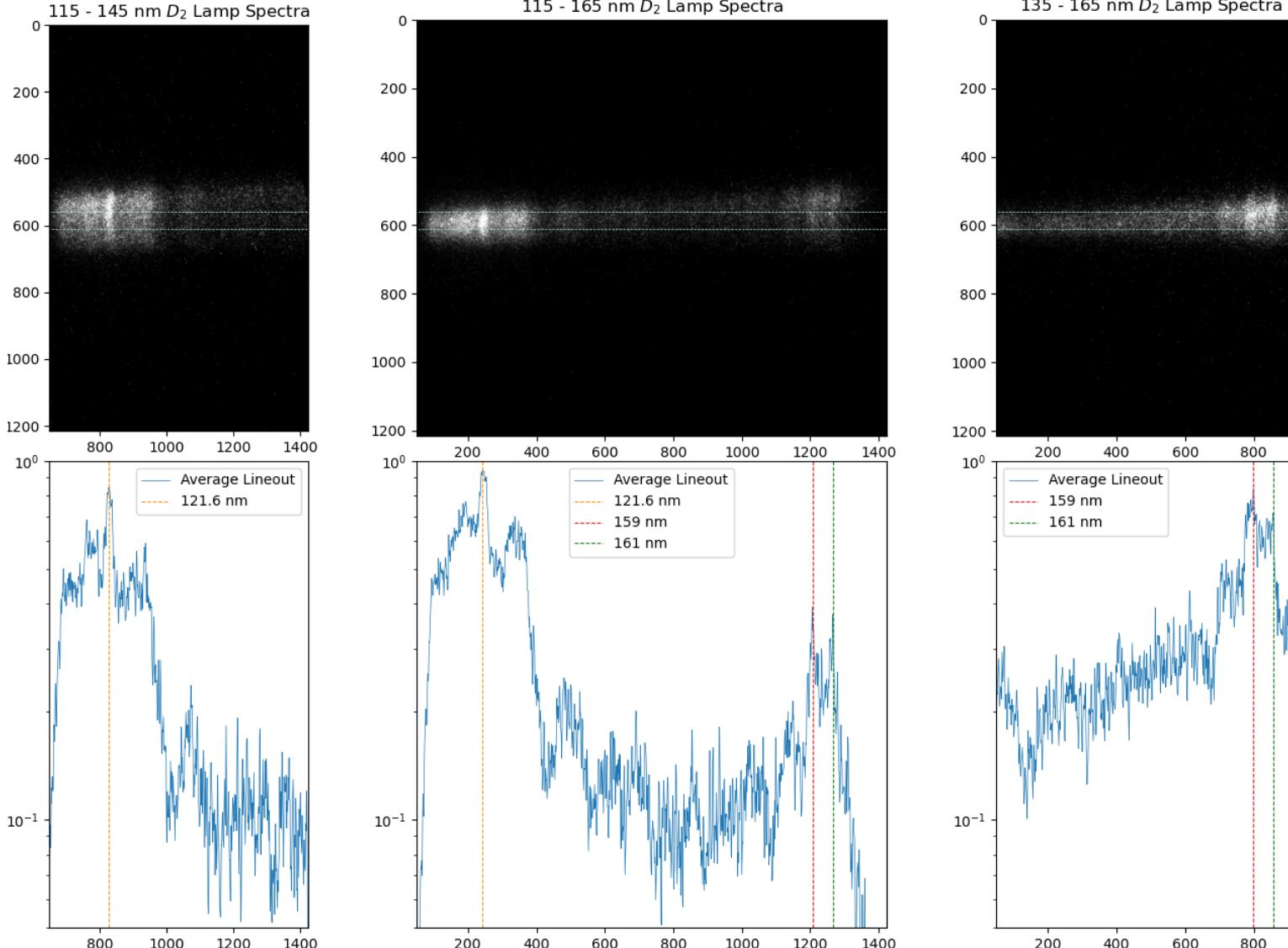
McPherson 234/302 VUV Spectrometer

- **Optical Design:** Abberation Corrected Seya-Namioka
- **f/#:** f/4.5
- **Focal Length:** 0.2 m
- **Gratings:** 600, 1200, 2400 g/mm
- **Grating Coatings:** Al + MgF₂
 - Pl for 2400 g/mm
- **Operating Wavelengths:** > 40 nm
- **Required Vacuum:** ~10⁻⁵ Torr
- **Linear Dispersion:** 4 nm/mm
- **Slit Width:** 0.1-3 mm

Photek iCMOS 160

- **Quantum Efficiency:** 20-25% (100-300 nm)
- **Gate Width:** > 3 ns
- **Window Size:** 25mm, 1920x1200 pixels
- **Pixel Size:** 13.3 μ m
- **Window Material:** MgF₂

First Collected Spectra Using Deuterium Lamp Source

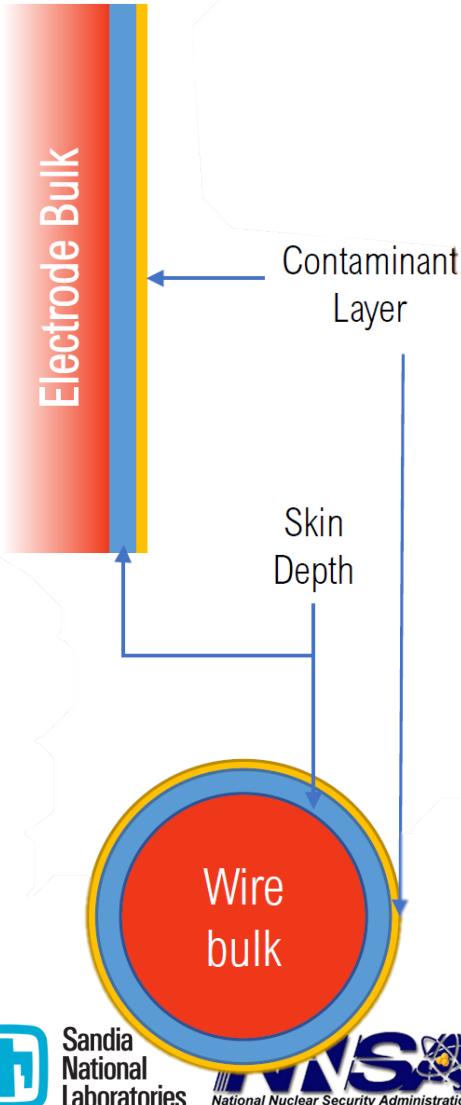


- 1200 g/mm Grating – 1400 Å Blazed
- 2 μ s Gate Width
- 70/100 Gain (Photek Camera)
- 50 μ m slit width
- Centered @ 1216 Å (left), 1440 Å (center), & 1600 Å (right)
 - Left and Right images are cropped

Electrode Surface Science – Upcoming Experiments



Foil Experiments



- Ohmic Heating occurs at skin depth of conductor
 - Heat transfers to foil/wire bulk and surface contaminant monolayers
- As bulk thickness decreases, how does the rate of contaminant layer desorption react?
 - Should be directly proportional to ohmic heating rather than other heating methods like ion/electron deposition
 - Finite energy in a current pulse. Thermal Energy scales from current density at skin depth layer (for planar geometry)
 - Heat transfer should take place from skin depth layer to bulk material and contaminant layer
 - Shot-to-shot, increasing bulk thickness in relation to skin depth of current pulse should increase the thermal energy deposited there rather in the contaminant layers (should act as a heat sink).
 - Conversely, shrinking the bulk material thickness should see more heat transferred to the contaminant layer, increasing the rate of material desorbed from the surface (and possibly electrode material melt)
 - Using spectroscopy, we should be able to measure the plasma density and thus the contaminant inventory from the wire/foil